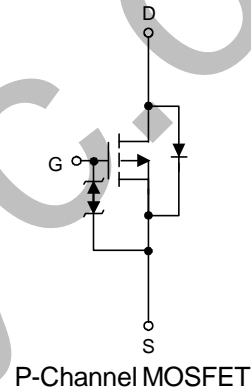
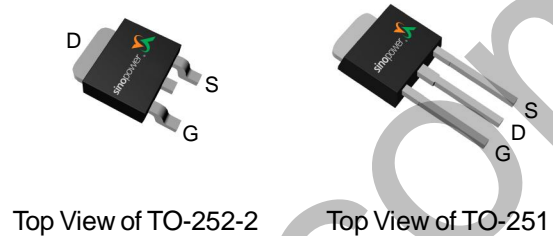


## P-Channel Enhancement Mode MOSFET

### Features

- 100V/-13A,  
 $R_{DS(ON)}=205m\Omega$  (max.) @  $V_{GS}=-10V$   
 $R_{DS(ON)}=300m\Omega$  (max.) @  $V_{GS}=-4V$
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)
- 100% UIS +  $R_g$  Tested

### Pin Configuration



### Applications

- Power Management in Desktop Computer or DC/DC Converters.

### Ordering and Marking Information

<p>SM1A16PS □□□-□□□</p> <div style="margin-left: 20px;"> <p>□□□ — Assembly Material</p> <p>□□ — Handling Code</p> <p>□ — Temperature Range</p> <p>□ — Package Code</p> </div>	<p>Package Code                  U : TO-252-2    UB : TO-251</p> <p>Operating Junction Temperature Range                  C : -55 to 150 °C</p> <p>Handling Code                  TR : Tape &amp; Reel for TO-252-2 Package                  TU : Tube for TO-251 Package</p> <p>Assembly Material                  G : Halogen and Lead Free Device</p>
<p>SM1A16PS U/UB :</p> <div style="border: 1px solid black; padding: 2px; display: inline-block;">  SM1A16P XXXXX                 </div>	<p>XXXXX - Lot Code</p>

Note : SINOPOWER lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. SINOPOWER lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. SINOPOWER defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

SINOPOWER reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
<b>Common Ratings</b> ( $T_A=25^\circ\text{C}$ Unless Otherwise Noted)				
$V_{DSS}$	Drain-Source Voltage	-100	V	
$V_{GSS}$	Gate-Source Voltage	$\pm 20$		
$T_J$	Maximum Junction Temperature	150	$^\circ\text{C}$	
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$	
$I_S$	Diode Continuous Forward Current	-1	A	
$I_{DP}$	300 $\mu\text{s}$ Pulse Drain Current Tested	$T_C=25^\circ\text{C}$	-52	A
		$T_C=100^\circ\text{C}$	-32	
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$	-13*	A
		$T_C=100^\circ\text{C}$	-8	
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	50	W
		$T_C=100^\circ\text{C}$	20	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	2.5	$^\circ\text{C/W}$	
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	50	$^\circ\text{C/W}$	

Note : \* Current limited by bond wire.

## Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	SM1A16PSU/UB			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_{DS}=-250\mu\text{A}$	-100	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-80\text{V}, V_{GS}=0\text{V}$	-	-	-1	$\mu\text{A}$
		$T_J=85^\circ\text{C}$	-	-	-30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=-250\mu\text{A}$	-1	-	-3	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 16\text{V}, V_{DS}=0\text{V}$	-	-	$\pm 10$	$\mu\text{A}$
$R_{DS(ON)}^a$	Drain-Source On-state Resistance	$V_{GS}=-10\text{V}, I_{DS}=-7.8\text{A}$	-	-	205	$\text{m}\Omega$
		$V_{GS}=-4\text{V}, I_{DS}=-6\text{A}$	-	-	300	
<b>Diode Characteristics</b>						
$V_{SD}^a$	Diode Forward Voltage	$I_{SD}=-1\text{A}, V_{GS}=0\text{V}$	-	-0.75	-1.1	V
$t_{rr}$	Reverse Recovery Time	$I_{DS}=-7.8\text{A},$ $dI_{SD}/dt=100\text{A}/\mu\text{s}$	-	34	-	ns
$Q_{rr}$	Reverse Recovery Charge	$dI_{SD}/dt=100\text{A}/\mu\text{s}$	-	59	-	nC

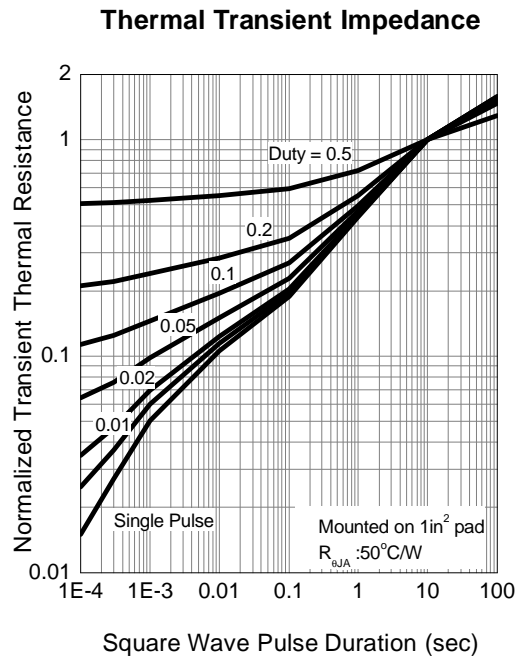
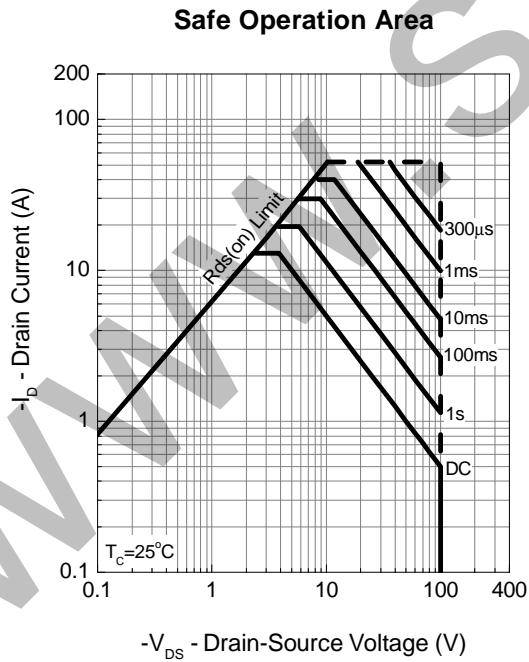
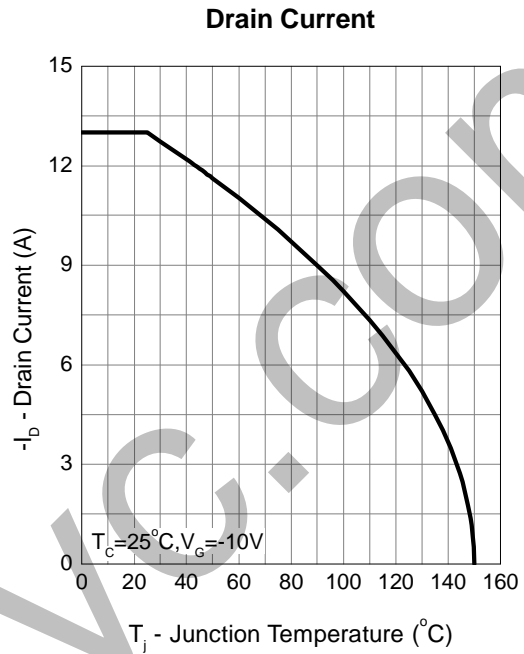
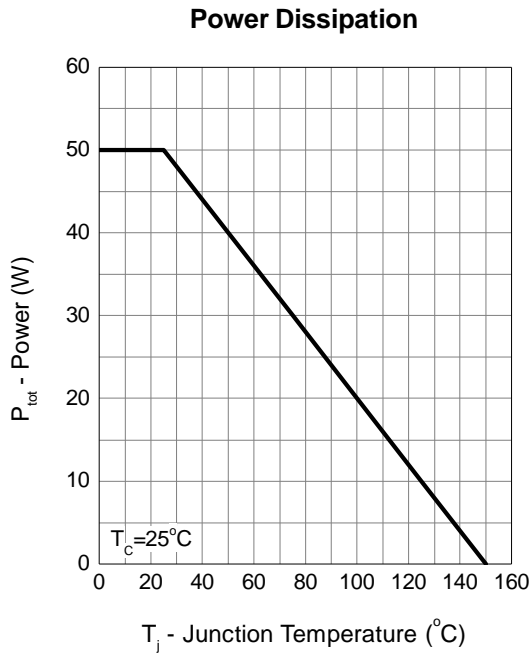
**Electrical Characteristics (Cont.)** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	SM1A16PSU/UB			Unit
			Min.	Typ.	Max.	
<b>Dynamic Characteristics<sup>b</sup></b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=-30V,$ Frequency=1.0MHz	-	1050	-	pF
$C_{oss}$	Output Capacitance		-	70	-	
$C_{rss}$	Reverse Transfer Capacitance		-	40	-	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=-30V, R_L=30\Omega,$ $I_{DS}=-1A, V_{GEN}=-10V,$ $R_G=6\Omega$	-	11	21	ns
$t_r$	Turn-on Rise Time		-	10	19	
$t_{d(OFF)}$	Turn-off Delay Time		-	55	100	
$t_f$	Turn-off Fall Time		-	30	55	
<b>Gate Charge Characteristics<sup>b</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=-50V, V_{GS}=-10V,$ $I_{DS}=-7.8A$	-	20.9	38	nC
$Q_{gs}$	Gate-Source Charge		-	4.2	-	
$Q_{gd}$	Gate-Drain Charge		-	5.2	-	

Note a : Pulse test ; pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ .

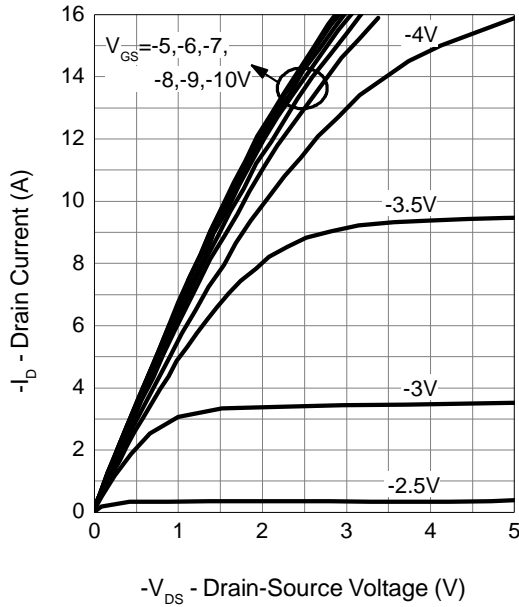
Note b : Guaranteed by design, not subject to production testing.

Typical Operating Characteristics

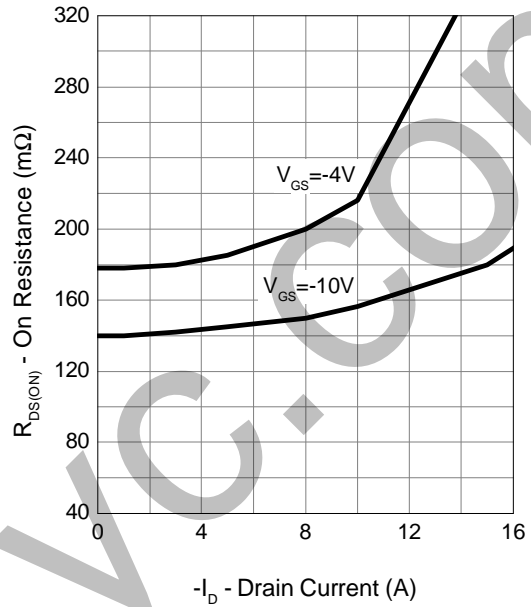


Typical Operating Characteristics (Cont.)

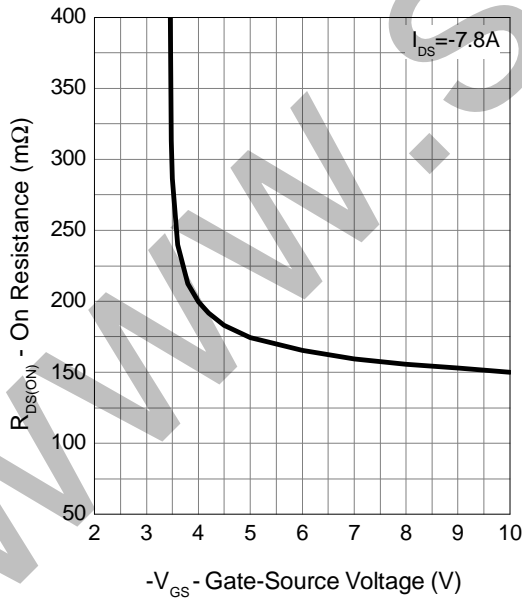
Output Characteristics



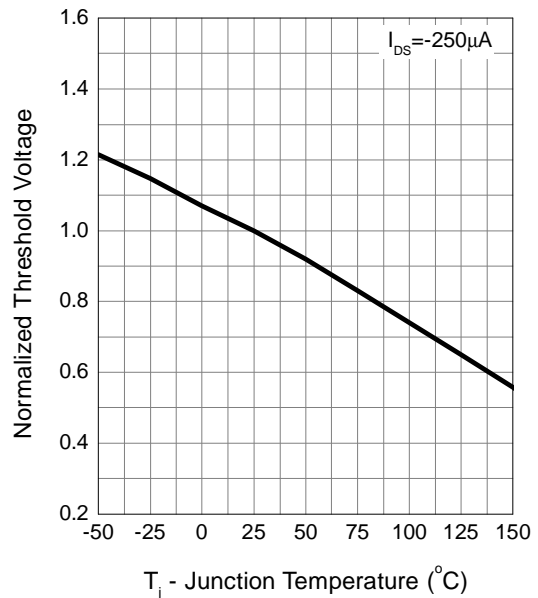
Drain-Source On Resistance



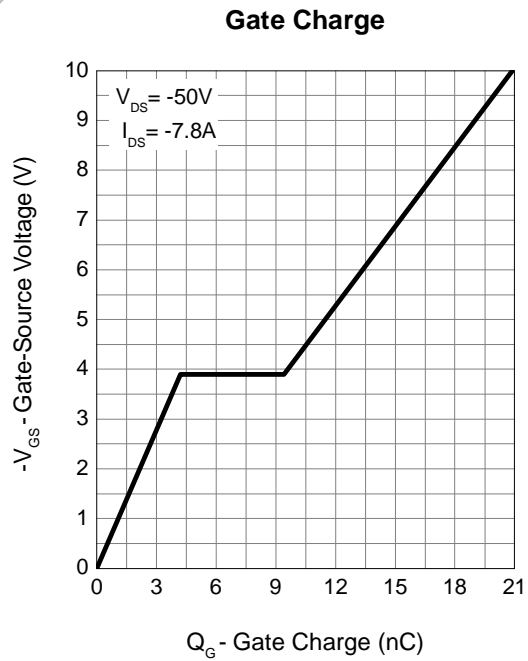
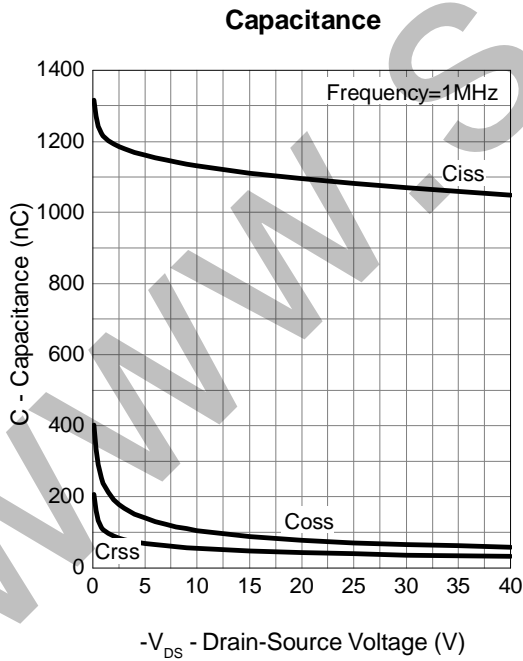
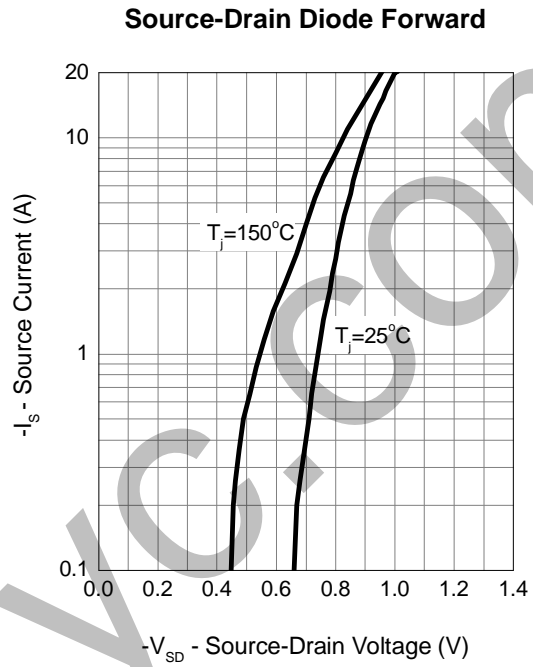
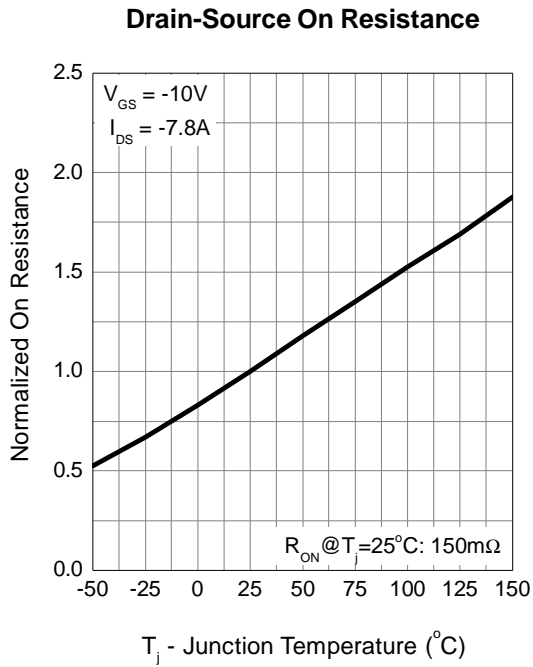
Gate-Source On Resistance



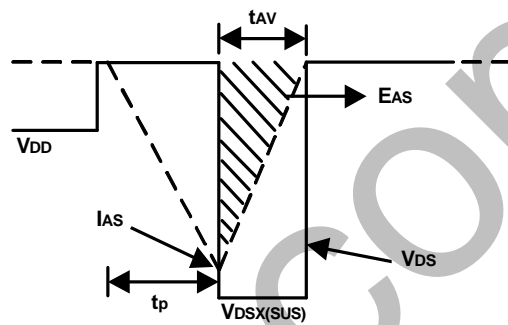
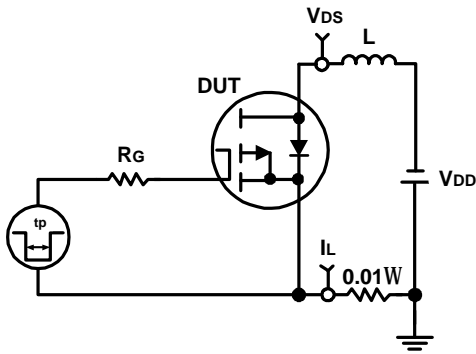
Gate Threshold Voltage



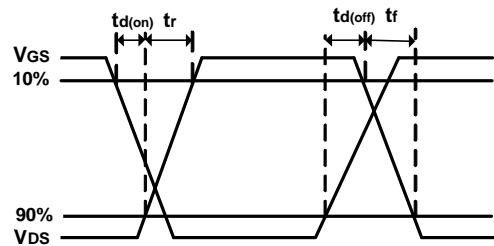
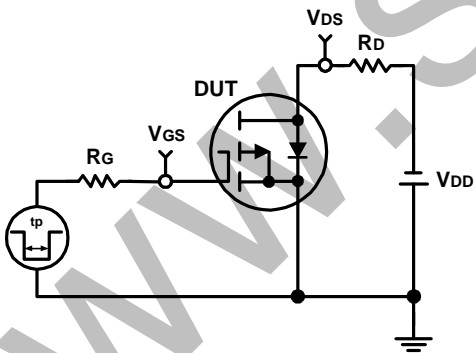
Typical Operating Characteristics (Cont.)



**Avalanche Test Circuit and Waveforms**



**Switching Time Test Circuit and Waveforms**



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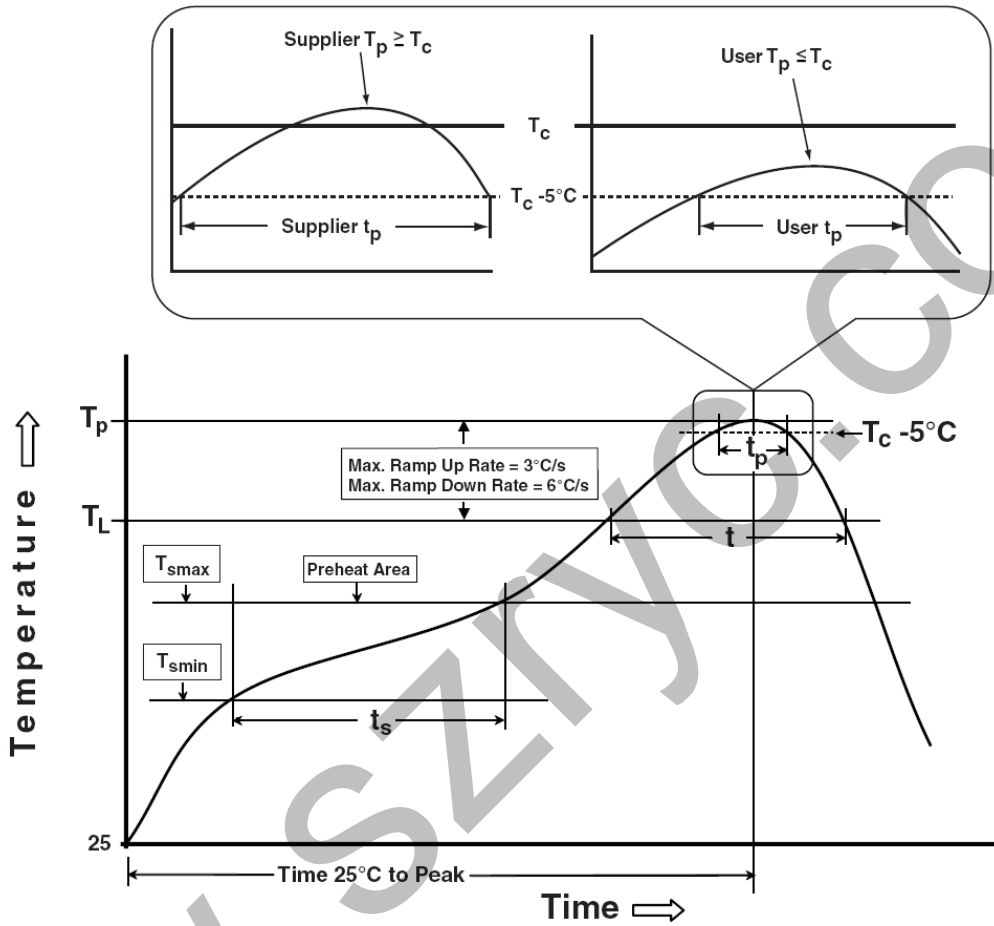
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Classification Profile



## Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
<b>Preheat &amp; Soak</b>		
Temperature min ( $T_{smin}$ )	100 °C	150 °C
Temperature max ( $T_{smax}$ )	150 °C	200 °C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 seconds	60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )	3 °C/second max.	3°C/second max.
Liquidous temperature ( $T_L$ )	183 °C	217 °C
Time at liquidous ( $t_L$ )	60-150 seconds	60-150 seconds
Peak package body Temperature ( $T_p$ )*	See Classification Temp in table 1	See Classification Temp in table 2
Time ( $t_p$ )** within 5°C of the specified classification temperature ( $T_c$ )	20** seconds	30** seconds
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature ( $t_p$ ) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

## Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	1000 Hrs, 80% of VDS max @ $T_{jmax}$
HTGB	JESD-22, A108	1000 Hrs, 100% of VGS max @ $T_{jmax}$
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C

## Customer Service

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